506267716 09/23/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6314462

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WENJUN ZHAO	09/23/2020
JIANHUA ZHANG	09/22/2020
GUOPENG ZHANG	09/23/2020
CHENGZHANG YANG	09/23/2020
HUI SUN	09/23/2020

RECEIVING PARTY DATA

Name:	SZ DJI TECHNOLOGY CO., LTD.
Street Address:	NO. 18 GAOXIN SOUTH 4TH AVENUE, NANSHAN DISTRICT
Internal Address:	17/F WEST WING, SKYWORTH SEMICONDUCTOR DESIGN BLDG
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518057

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17029973

CORRESPONDENCE DATA

Fax Number: (703)935-1394

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

7034305759 Phone:

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ANOVA LAW GROUP, PLLC **Correspondent Name:**

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Address Line 4: STERLING, VIRGINIA 20166

ATTORNEY DOCKET NUMBER:	00203.3504.00US
NAME OF SUBMITTER:	HOI CHEUNG
SIGNATURE:	/Hoi Cheung/
DATE SIGNED:	09/23/2020

Total Attachments: 4

PATENT REEL: 053863 FRAME: 0083



PATENT REEL: 053863 FRAME: 0084

accordance with the terms of this Assignment

ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:

ENCODING METHOD AND APPARATUS, IMAGE PROCESSING SYSTEM, AND COMP READABLE STORAGE MEDIUM	UTER-
for which I/We executed an application for United States Letters Patent herewith, as a national in the United States of PCT Application No. <u>PCT/CN2018/082026</u> , or filed an application for Ur Letters Patent on(Application No); and	application ited States
WHEREAS, <u>SZ DJI TECHNOLOGY CO., LTD.</u> , a limited company of <u>P.R. China.</u> whos office address is 17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South Nanshan District. Shenzhen, Guangdong, 518057, P.R. China (hereinafter referred to as Assig desirous of securing the entire right, title, and interest in and to this invention in United States, of the application for United States Letters Patent on this invention and the Letters Patent to be upon this application.	4 ⁱⁿ Avenue nce), is and in and
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, over, and do hereby self, assign, transfer, and set over unto the Assignee, its lawful successors assigns, my/our entire right, title, and interest in and to this invention, provisional Application N	and set and
filed(If any), and this application, and all divisions, substitutions, continuations, a continuations-in-part thereof, and all Letters Patent of the United States which may be granted and all reissues thereof, and all rights to claim priority on the basis of the above provisional applicant and all rights to claim priority on the basis of this application, and all applications for Patent which may hereafter be filed for this invention in any foreign country and all Letters Pate may be granted on this invention in any foreign country, and all extensions, renewals, and reiss thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks United States and any official of any foreign country whose duty it is to issue patents on applica	nd thereon, lication (if Letters nt which ues of the

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application, to insert here in parentheses (Application No. $\underline{17029973}$, filed $\underline{\underline{September 23, 2020}}$) the filing date and application number of said application when known.

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IN T	ESTIMONY WHEREOF, I/We have hereunto set our hands.
lnve	entor 1;
Name:	Wenjun ZHAO
Address:	17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong 518057 P.R. China
Signature:	Wenjan Zhao
Date:	2020 - 9 - 23
Inve	entor 2:
Name:	Jianhua ZHANG
Address:	17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong 518057 P.R. China
Signature:	
Date:	
,	
Inve	entor 3:
Name:	Guopeng ZHANG
Address:	17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong 518057 P.R. China
Signature:	Company 24AHQ
Date:	2010. 9.25

INT	restimony whereof, l/we have hereunto set our hands.
inve	entor 1:
Name:	Wenjun ZHAO
Address:	17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong 518057 P.R. China
Signature:	
Date:	
Inve	entor 2:
Name:	Jianhua ZHANG
Address:	17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong 518057 P.R. China
Signature:	Jianhua ZHANG
Date:	2020.9.22
Inve	entor 3:
Name:	Guopeng ZHANG
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Signature:	
Date:	

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2020. 9.23

Inventor 4:	
Name:	Chengzhang YANG
Address:	17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong 518057 P.R. China
Signature:	cheny zhong Yang
Date:	62.4.23
Inv	entor 5:
Name:	Hui SUN
Address:	17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong 518057 P.R. China
Signature:	Hui SUW

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Date: